

QFN16 3x3, 0.5P CASE 485FM **ISSUE A**

DATE 30 JAN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION & APPLIES TO PLATED
 TERMINAL AND IS MEASURED BETWEEN
- 0.25 AND 0.30 MM FROM TERMINAL. COPLANARITY APPLIES TO THE EXPOSED
- PAD AS WELL AS THE TERMINALS.
 OUTLINE MEETS JEDEC DIMENSIONS PER
 MO–220, VARIATION VEED–6.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.80	1.00
A1	0.00	0.05
A3	0.20 REF	
b	0.18	0.30
D	3.00 BSC	
D2	1.25	1.55
E	3.00 BSC	
E2	1.25	1.55
е	0.50 BSC	
K	0.20	
1	0.30	0.50

GENERIC MARKING DIAGRAM*



= Assembly Location

= Wafer Lot

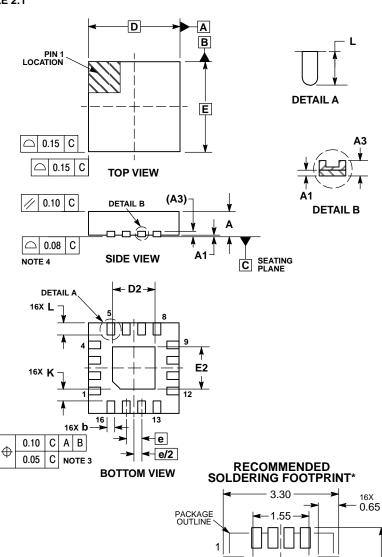
= Year

W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.



16X 0.30

DIMENSIONS: MILLIMETERS *For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

0.50 PITCH

1.55 3.30

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